

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Cheng-Tzu Thomas Hsu</td> <td>12/22/2010</td> </tr> <tr> <td>Sun Punurai</td> <td>12/22/2010</td> </tr> <tr> <td>Pedro R. Munoz</td> <td>12/21/2010</td> </tr> </tbody> </table>		Name	Execution Date	Cheng-Tzu Thomas Hsu	12/22/2010	Sun Punurai	12/22/2010	Pedro R. Munoz	12/21/2010		
Name	Execution Date										
Cheng-Tzu Thomas Hsu	12/22/2010										
Sun Punurai	12/22/2010										
Pedro R. Munoz	12/21/2010										
RECEIVING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>New Jersey Institute of Technology</td> </tr> <tr> <td>Street Address:</td> <td>University Heights</td> </tr> <tr> <td>City:</td> <td>Newark</td> </tr> <tr> <td>State/Country:</td> <td>NEW JERSEY</td> </tr> <tr> <td>Postal Code:</td> <td>07102-1982</td> </tr> </table>		Name:	New Jersey Institute of Technology	Street Address:	University Heights	City:	Newark	State/Country:	NEW JERSEY	Postal Code:	07102-1982
Name:	New Jersey Institute of Technology										
Street Address:	University Heights										
City:	Newark										
State/Country:	NEW JERSEY										
Postal Code:	07102-1982										
PROPERTY NUMBERS Total: 1											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12857670</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12857670						
Property Type	Number										
Application Number:	12857670										
CORRESPONDENCE DATA											
<p>Fax Number: (203)399-5822</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 203-399-5900</p> <p>Email: BNABULSI@MCCARTER.COM</p> <p>Correspondent Name: MCCARTER & ENGLISH, LLP STAMFORD</p> <p>Address Line 1: CANTERBURY GREEN</p> <p>Address Line 2: 201 BROAD STREET, 9TH FLOOR</p> <p>Address Line 4: STAMFORD, CONNECTICUT 06901</p>											
ATTORNEY DOCKET NUMBER:	94350.00087										
NAME OF SUBMITTER:	Basam E. Nabulsi										
<p>Total Attachments: 6</p> <p>source=NJIT_00087_Assignment1#page1.tif</p>											

CH \$40.00 12857670

501416663

PATENT
REEL: 025695 FRAME: 0413

source=NJIT_00087_Assignment1#page2.tif
source=NJIT_00087_Assignment2#page1.tif
source=NJIT_00087_Assignment2#page2.tif
source=NJIT_00087_Assignment3#page1.tif
source=NJIT_00087_Assignment3#page2.tif

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged,
I/we the undersigned,

Cheng-Tzu Thomas Hsu, 6 Union Hill Lane, Hazlet, NJ 07730

Sun Punurai, 36, Moo 8, Thungmangon 3, Chimplee, Talingchan, Bangkok, Thailand 10170
--

Pedro R. Munoz, 6 Woodman Way, Apt. #116, Newburyport, Ma 01950

(insert full name(s) and post office addresses of inventors)

(hereinafter, "Assignor"), who have created a certain invention for which a provisional application has been filed with the United States Patent Office entitled:

SYSTEM AND METHOD OF USE FOR COMPOSITE FLOOR

(insert title of invention)

and

- ☐ for which the application is attached hereto; or
- ☒ for which the application for U.S. Letters Patent has been filed on August 17, 2010 as Application Serial No. 12/857,670.

Do hereby sell, assign and transfer to:

New Jersey Institute of Technology, University Heights, Newark, NJ 07102-1982

(insert full name(s) and post office addresses of assignee)

(hereinafter, "Assignee"), its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all non-provisional applications, continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

I/We authorize Assignee to apply for and receive Letters Patent for such protection in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, but without charge to Assignee, its successors, assigns and legal representatives, the undersigned will execute all non-provisional applications, continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF, I/we have hereunto set our signature(s) below

Signature of inventor:

Date: 12/22/2010


Cheng-Tzu Thomas Hsu


Signature of inventor:

Date: _____

Sun Punurai

Signature of inventor:

Date: 12/21/2010


Pedro R. Munoz

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged,
I/we the undersigned,

Cheng-Tzu Thomas Hsu, 6 Union Hill Lane, Hazlet, NJ 07730
Sun Punurai, 36, Moo 8, Thungmangon 3, Chimplee, Talingchan, Bangkok, Thailand 10170
Pedro R. Munoz, 6 Woodman Way, Apt. #116, Newburyport, Ma 01950

(insert full name(s) and post office addresses of inventors)

(hereinafter, "Assignor"), who have created a certain invention for which a provisional application has been filed with the United States Patent Office entitled:

SYSTEM AND METHOD OF USE FOR COMPOSITE FLOOR

(insert title of invention)

and

- ☐ for which the application is attached hereto; or
- ☒ for which the application for U.S. Letters Patent has been filed on August 17, 2010 as Application Serial No. 12/857,670.

Do hereby sell, assign and transfer to:

New Jersey Institute of Technology, University Heights, Newark, NJ 07102-1982

(insert full name(s) and post office addresses of assignee)

(hereinafter, "Assignee"), its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all non-provisional applications, continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

I/We authorize Assignee to apply for and receive Letters Patent for such protection in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, but without charge to Assignee, its successors, assigns and legal representatives, the undersigned will execute all non-provisional applications, continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF, I/we have hereunto set our signature(s) below.

Signature of inventor:

Date: _____

Cheng-Tzu Thomas Hsu

Signature of inventor:

Date: 22/12/2010



Sun Punurai

Signature of inventor:

Date: _____

Pedro R. Munoz

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we the undersigned,

Cheng-Tzu Thomas Hsu, 6 Union Hill Lane, Hazlet, NJ 07730
Sun Punurai, 36, Moo 8, Thungmangon 3, Chimplee, Talingchan, Bangkok, Thailand 10170
Pedro R. Munoz, 6 Woodman Way, Apt. #116, Newburyport, Ma 01950

(insert full name(s) and post office addresses of inventors)

(hereinafter, "Assignor"), who have created a certain invention for which a provisional application has been filed with the United States Patent Office entitled:

SYSTEM AND METHOD OF USE FOR COMPOSITE FLOOR

(insert title of invention)

and

- ☐ for which the application is attached hereto; or
- ☒ for which the application for U.S. Letters Patent has been filed on August 17, 2010 as Application Serial No. 12/857,670.

Do hereby sell, assign and transfer to:

New Jersey Institute of Technology, University Heights, Newark, NJ 07102-1982

(insert full name(s) and post office addresses of assignee)

(hereinafter, "Assignee"), its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all non-provisional applications, continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

I/We authorize Assignee to apply for and receive Letters Patent for such protection in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, but without charge to Assignee, its successors, assigns and legal representatives, the undersigned will execute all non-provisional applications, continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF, I/we have hereunto set our signature(s) below.

Signature of inventor:

Date: _____

Cheng-Tzu Thomas Hsu

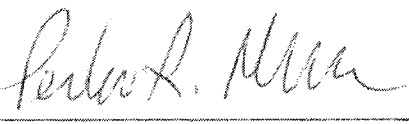
Signature of inventor:

Date: 02/12/2010

Sun Punurai

Signature of inventor:

Date: 12/21/2010


Pedro R. Munoz